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1. Name of conveying party(ies):  
Chia-Shing Chou  
  
Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies)  
Name: Wireless MEMS Incorporated  
  
Internal Address: \_\_\_\_\_  
  
Street Address: 517 Hastings Court  
  
City: Oak Park State: CA Zip: 91377  
  
Additional name(s) & address(es) attached? ☐ Yes ☒ No

3. Nature of conveyance:  
☒ Assignment ☐ Merger  
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Execution Date: 11/07/2004


4. Application number(s) or patent number(s):  
If this document is being filed together with a new application, the execution date of the application is: \_\_\_\_\_  
A. Patent Application No.(s) 10/783,772  
B. Patent No.(s) \_\_\_\_\_  
  
Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:  
Name: TOPE MCKAY & ASSOCIATES  
  
Internal Address: \_\_\_\_\_  
  
Street Address: \_\_\_\_\_  
23852 Pacific Coast Highway #311  
  
City: Malibu State: CA Zip: 90265

6. Total number of applications and patents involved: 1  
  
7. Total fee (37 CFR 3.41).....\$ 40.00  
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PATENT  
REEL: 015978 FRAME: 0642

**Invention Title: FABRICATION METHOD FOR MAKING A PLANAR CANTILEVER, LOW SURFACE LEAKAGE, REPRODUCIBLE AND RELIABLE METAL DIMPLE CONTACT MICRO-RELAY MEMS SWITCH**

**ASSIGNMENT**

WHEREAS, I, Chia-Shing Chou of 517 Hastings Court, Oak Park, California 91377 United States of America (hereinafter "Assignor") have invented certain new and useful improvements in **FABRICATION METHOD FOR MAKING A PLANAR CANTILEVER, LOW SURFACE LEAKAGE, REPRODUCIBLE AND RELIABLE METAL DIMPLE CONTACT MICRO-RELAY MEMS SWITCH** (hereinafter "Invention") for which an application for a United States Patent was filed on 02/20/2004, Application Number 10/783,772 and/or for which Assignors are making or have made a foreign application for intellectual or industrial property protection under the appropriate body of law corresponding to that foreign jurisdiction.

AND

WHEREAS, **Wireless MEMS Incorporated**, a corporation organized and existing under the laws of the State of Delaware, United States of America and having a place of business at 517 Hastings Court, Oak Park, California 91377, United States of America, (hereinafter "Assignee"), is desirous of acquiring the entire right, title, and interest in the Invention within the United States of America and its territorial possessions, and in all foreign countries in which intellectual or industrial property protection may be granted therefor.

NOW, THEREFORE, for good and valuable consideration, the receipt whereof is hereby acknowledged, I, the Assignor desire to and do hereby assign, sell, and transfer unto Assignee the full and exclusive right to the Invention in the United States of America and its territorial possessions and in all foreign countries, as well as, the entire right, title and interest in and to any and all intellectual or industrial property rights including, but not limited to, Patents, designs, utility models, and inventor certificates which may be granted therefore in the United States of America and its territorial possessions and in all foreign countries, I hereby authorize and request the U.S. Patent Offices and the equivalent offices at foreign countries, to issue to the Assignee, any and all applicable intellectual or industrial property rights in the Invention, for the Assignee's sole use and benefit; and for the use and benefit of his legal representatives, to the full end of the term for which United States and foreign Patents or the like may be granted, as fully and entirely as the same would have been held by me had this assignment and sale not been made.

I further covenant and agree with the Assignee that I have a full and unencumbered title to the invention hereby assigned, which title I warrant unto the Assignee, and I further agree that I will, without demanding any further consideration therefore, at the request and at the expense of the Assignee, do all lawful and just acts, including the execution and acknowledgment of instruments, that may be or become necessary for obtaining, sustaining, extending, reissuing or reexamining United States and foreign Patents or the like for the Invention, and for maintaining and perfecting the Assignee's right to the Invention and any and all intellectual or industrial property rights in it, particularly in cases of interference, conflict, opposition and litigation.

IN TESTIMONY WHEREOF, I have hereunto set my hand.

Executed this seventh day of November, 2004,

at Oak Park (city).

  
(Signature)